

Development Board EPC9010C Quick Start Guide

100 V Half-bridge with Gate Drive, Using EPC2016C

Revision 3.0



Boost Converter configuration

Warning: Never operate the boost converter mode without a load as the output voltage can increase beyond the maximum ratings.

1. The inductor (L_1) and input capacitors (labeled as C_{out}) can either be soldered onto the board, as shown in figure 3, or provided off board. Anti-parallel diodes can also be installed using the additional pads on the right side of the EPC2016C FETs.
2. With power off, connect the input power supply bus to V_{OUT} (J9, Pin-1) and ground / return to GND (J9, Pin-2), or externally across the capacitor if the inductor L_1 and C_{out} are provided externally. Connect the output voltage (labeled as V_{IN} , J5, J6) to your circuit as required, e.g., resistive load.
3. With power off, connect the gate drive supply to V_{DD} (J1, Pin-1) and ground return to GND (J1, Pin-2 indicated on the bottom side of the board).
4. With power off, connect the input PWM control signal to PWM1 (J2, Pin-1) and ground return to any of GND J2 pins indicated on the bottom side of the board. Note that the bottom FET gate drive signal is inverted with regard to PWM1. It is also possible to use separate input PWM signals by removing R2 and R17 and installing 0 Ω jumpers for R14 and R16.
5. Turn on the gate drive supply – make sure the supply is between 7.5 V and 12 V.
6. Turn on the controller / PWM input source.
7. Making sure the output is not open circuit, and the input supply voltage is initially 0 V, turn on the power and slowly increase the voltage to the required value (do not exceed the absolute maximum voltage). Probe switching node to see switching operation.
8. Once operational, adjust the PWM control, bus voltage, and load within the operating range and observe the output switching behavior, efficiency and other parameters. Observe device temperature for operational limits.
9. For shutdown, please follow steps in reverse.

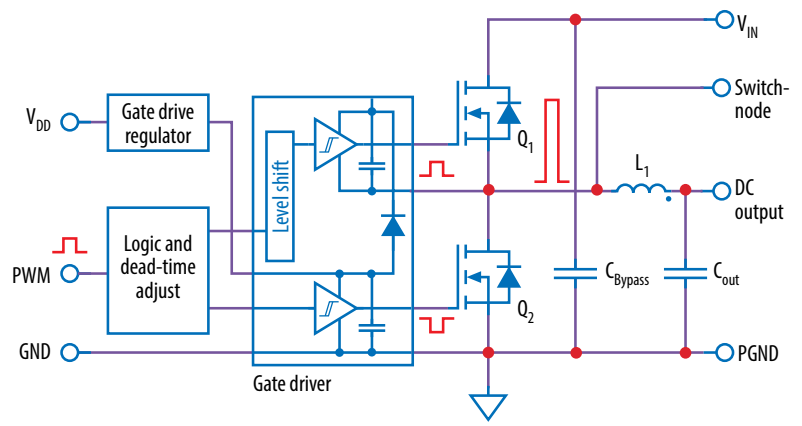


Figure 1: Block diagram of EPC9101C development board

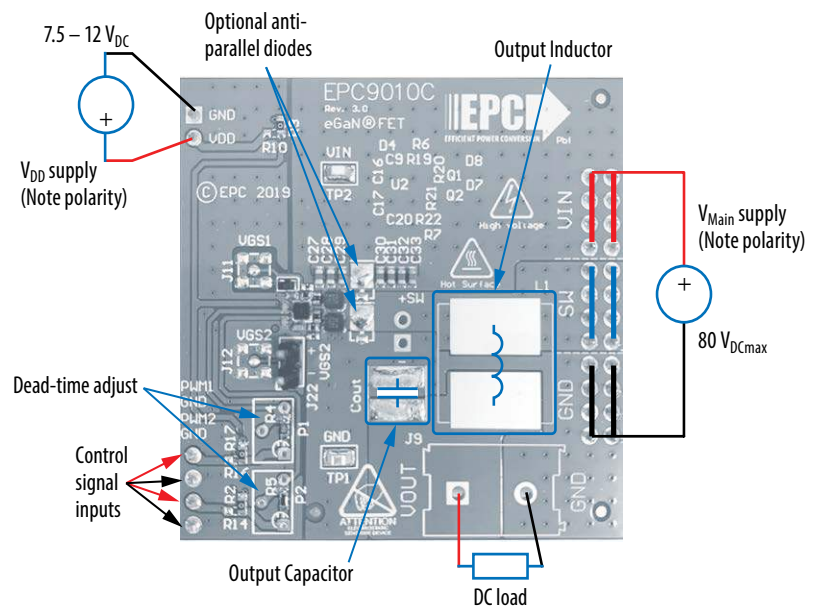


Figure 2: Buck configuration

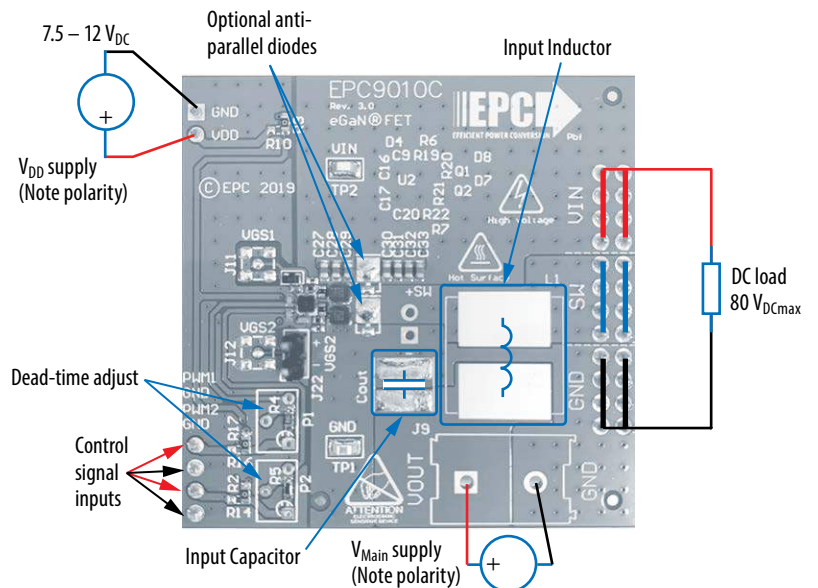


Figure 3: Boost configuration

THERMAL CONSIDERATIONS

The EPC9010C development board showcases the EPC2016C eGaN FET. The EPC9010C is intended for bench evaluation with low ambient temperature and convection cooling. The addition of heat-sinking and forced air cooling can significantly increase the current rating of these devices, but care must be taken to not exceed the absolute maximum die temperature of 150° C.

NOTE. The EPC9010C development board does not have any current or thermal protection on board. For more information regarding the thermal performance of EPC eGaN FETs, please consult:

D. Reusch and J. Glaser, *DC-DC Converter Handbook*, a supplement to *GaN Transistors for Efficient Power Conversion*, First Edition, Power Conversion Publications, 2015.

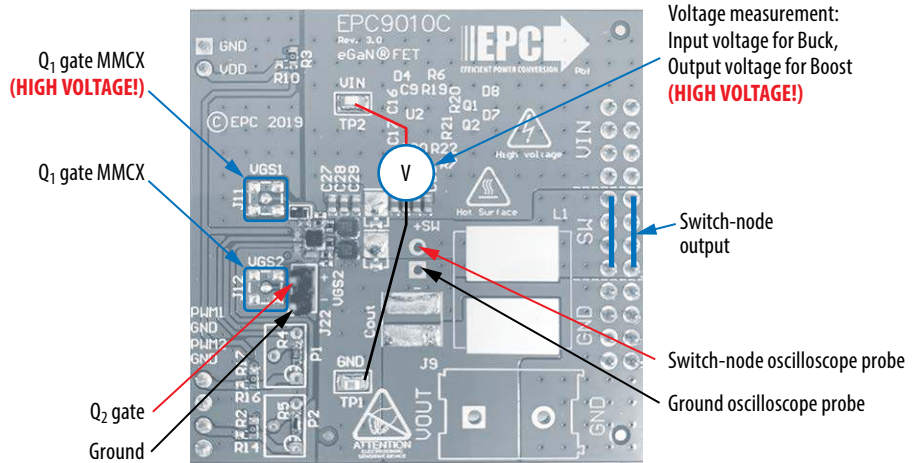


Figure 4: Measurement top side

MEASUREMENT CONSIDERATIONS

When measuring the high frequency content switch node, care must be taken to provide an accurate high speed measurement. An optional two pin header (J10) is included for switch node measurement. MMCX connector footprint is also provided (J15) to measure switch node.

Low-side gate voltage (VGS2) can be measured at the two pin header (J22) or the MMCX (J12). Please refer to figure 4. R7 (0 Ohm resistor) will need to be installed.

High-side gate voltage (VGS1) can only be measured using the MMCX connector (J11). Please refer to figure 4. R6 (0 Ohm resistor) will need to be installed.

Differential probe is recommended for measuring high-side gate. IsoVu probes from Tektronix has mating MMCX connector.

For regulator passive voltage probes (e.g. TPP1000) measuring low-side gate or switch node using MMCX connector, probe adaptor is available. PN: 206-0663-xx.

NOTE. For information about measurement techniques, the EPC website offers: “AN023 Accurately Measuring High Speed GaN Transistors” and the How to GaN educational video series, including: HTG09- Measurement

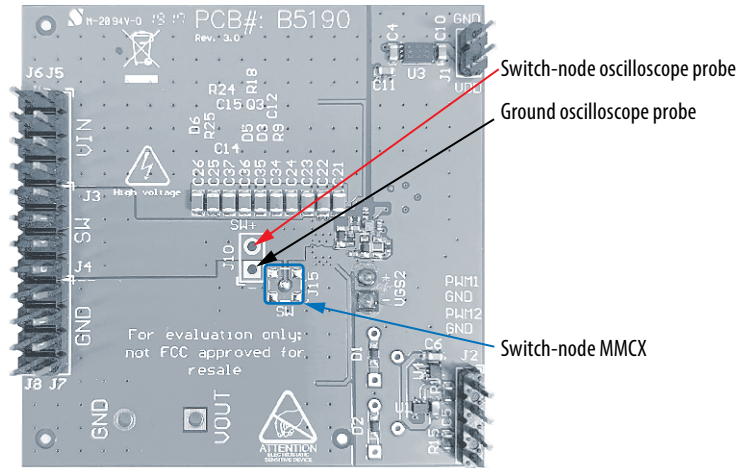


Figure 5: Measurement bottom side

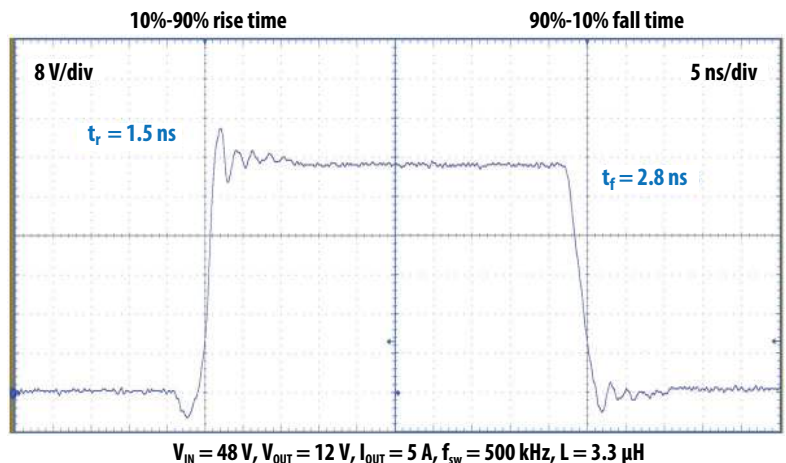


Figure 6: Typical switch-node waveform when operated as a buck converter

Table 2: Bill of Materials

Item	Qty	Reference	Part Description	Manufacturer	Part Number
1	3	C4, C10, C11	Capacitor, 1 µF, 10%, 25 V, X7R	TDK	C1608X7R1E105K
2	2	C5, C6	Capacitor, 0.1 µF, 10%, 25 V, X7R	TDK	C1608X7R1E104K
3	1	C9	Capacitor, 0.1 µF, 10%, 25 V, X7R	Yageo	CC0402KRX7R8BB104
4	2	C12, C14	Capacitor, 0.1 µF, 10%, 16 V, X7R	Murata	GRM155R71C104KA88D
5	1	C15	Capacitor, 0.022 µF, 10%, 25 V, X7R	TDK	C1005X7R1E223K050BB
6	2	C16, C17	Capacitor, 100 pF, 10%, 50 V, X7R	Yageo	CC0402KRX7R9BB101
7	1	C20	Capacitor, 4.7 µF, 10%, 10 V, X5R	TDK	C1005X5R1A475K050BC
8	10	C21, C22, C23, C24, C25, C26, C34, C35, C36, C37	Capacitor, 1 µF 100 V 20% X7S	TDK	C2012X7S2A105M125AB
9	7	C27, C28, C29, C30, C31, C32, C33	Capacitor, 0.22 µF, 10%, 100 V, X7S	Taiyo Yuden	HMK107C7224
10	4	D1, D2, D5, D6	Schottky Diode, 30 V, 30 mA	Diodes Inc.	SDM03U40
11	1	D3	Schottky Diode, 40 V, 300 mA	ST	BAT54KFILM
12	1	D4	Zeer Diode, 5.1 V, 150 mW	Bournes	CD0603-Z5V1
13	2	D7, D8	Schottky Diode, 100 V, 2 A	Vishay	SS2PH10-M3
14	2	Q1, Q2	eGaN FET, 100 V, 11 A, 16mΩ	EPC	EPC2016C
15	1	Q3	eGaN FET, 100 V, 0.5 A, 3300mΩ	EPC	EPC2038
16	1	U1	IC GATE NAND 1CH 2-INP 6MICROPAK	Fairchild	NC7SZ00L6X
17	1	U2	100 V eGaN Driver	uPI	uP1966A
18	1	U3	Linear Voltage Regulator IC P, 5 V, 250 mA	Microchip	MCP1703T-5002E/MC
19	1	U4	IC GATE AND 1CH 2-INP 6-MICROPAK	Fairchild	NC7SZ08L6X
20	2	R1, R15	Resistor, 10.0 k, 5%, 1/10 W	Yageo	RC0603JR-0710KL
21	3	R2, R3, R17	Resistor, 0 Ω, 1/10 W	Stackpole	RMCF0603ZTOR00
22	1	R4	Resistor, 150 Ω, 1%	Stackpole	RMCF0603FT150R
23	1	R5	Resistor, 200 Ω, 1%	Stackpole	RMCF0603FT200R
24	1	R9	RES SMD 0.0 Ω Jumper 1/16 W	Stackpole	RMCF0402ZTOR00
25	2	R19, R21	Resistor, 2.7 Ω, 5%, 1/10 W	Panasonic	ERJ-2GEJ2R7X
26	2	R20, R22	Resistor, 500 mΩ, 1%, 1/8 W	Yageo	PT0402FR-7W0R5L
27	1	R24	Resistor, 27 kΩ, 5%, 1/10 W	Panasonic	ERJ-2GEJ273X
28	1	R25	Resistor, 20 Ω, 5%, 1/16 W	Stackpole	RMCF0402JT20R0
29	2	J1, J22	Connector, .1" Male Vert.	Würth	61300211121
30	7	J2, J3, J4, J5, J6, J7, J8	Connector, .1" Male Vert.	Tyco	4-103185-0-04
31	1	J10	Connector, .1" Male Vert.	Würth	61300211121
32	2	TP1, TP2	SMT test point	Keystone	5015

Optional Components

Item	Qty	Reference	Part Description	Manufacturer	Part Number
1	1	Cout	TBD	Generic	Generic
2	1	L1	TBD	Generic	Generic
3	3	R10, R14, R16	Resistor, 0 Ω, 1/10 W	Stackpole	RMCF0603ZTOR00
4	2	R6, R7	Resistor, 0.0 Ω, 1/16 W	Stackpole	RMCF0402ZTOR00
5	1	R18	Resistor, 4.7 Ω, 5%, 1/10 W	Panasonic	ERJ-2GEJ4R7X
6	3	J11, J12, J15	MMCX Connector Jack	Molex	734152063
7	1	J9	7.62 mm Euro Term.	Würth	691216410002
8	2	P1, P2	Trimmer, 1 kΩ, 1/4 W	Murata	PV37W102C01B00

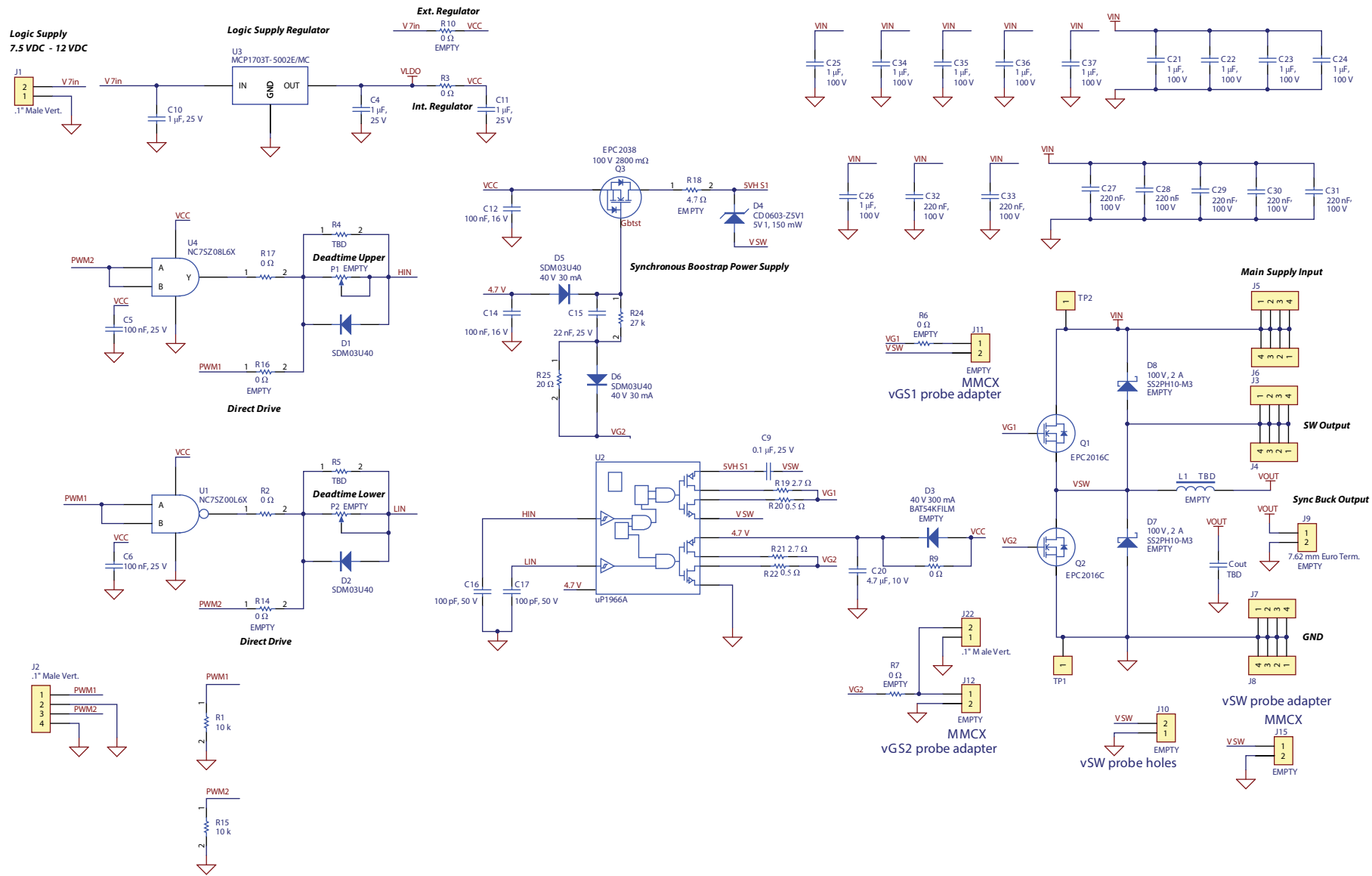


Figure 7: EPC9010C - Schematic

For More Information:

Please contact info@epc-co.com
or your local sales representative

Visit our website:
www.epc-co.com

Sign-up to receive
EPC updates at
bit.ly/EPCupdates
or text "EPC" to 22828



EPC Products are distributed through Digi-Key.
www.digikey.com

Demonstration Board Notification

The EPC9010C board is intended for product evaluation purposes only. It is not intended for commercial use nor is it FCC approved for resale. Replace components on the Evaluation Board only with those parts shown on the parts list (or Bill of Materials) in the Quick Start Guide. Contact an authorized EPC representative with any questions. This board is intended to be used by certified professionals, in a lab environment, following proper safety procedures. Use at your own risk.

As an evaluation tool, this board is not designed for compliance with the European Union directive on electromagnetic compatibility or any other such directives or regulations. As board builds are at times subject to product availability, it is possible that boards may contain components or assembly materials that are not RoHS compliant. Efficient Power Conversion Corporation (EPC) makes no guarantee that the purchased board is 100% RoHS compliant.

The Evaluation board (or kit) is for demonstration purposes only and neither the Board nor this Quick Start Guide constitute a sales contract or create any kind of warranty, whether express or implied, as to the applications or products involved.

Disclaimer: EPC reserves the right at any time, without notice, to make changes to any products described herein to improve reliability, function, or design. EPC does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, or other intellectual property whatsoever, nor the rights of others.